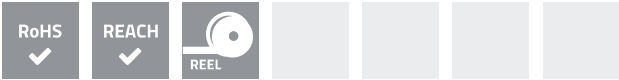


SMD contact springs are ideal for automatic assembly on printed circuit boards. They are soldered by the standard-reflow-soldering process.

The standard basic material used for SMD contact springs is copper beryllium (CuBe). However, other materials can also be supplied.

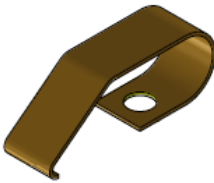
As standard, SMD springs are gold-plated (AU). They can be supplied in a wide range of dimensions and shapes.

- Ideal for automatic assembly
- Standard basic material: CuBe
- Standard plating: AU
- Available in different dimensions and types
- Almost unlimited working life

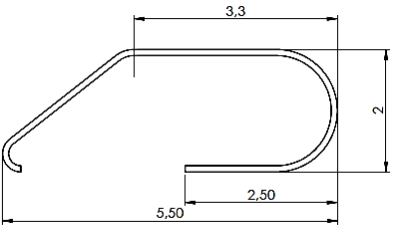
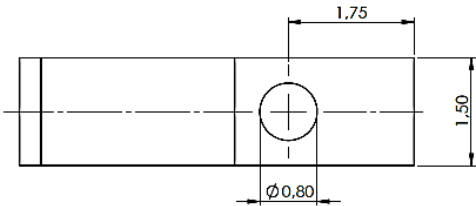


PRODUCT SPECIFICATIONS

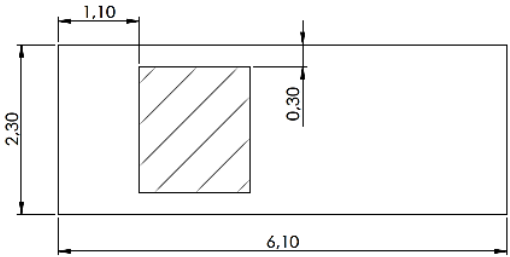
PROPERTY		VALUE / TOLERANCE
Thickness		0,1 mm
Width		1,5 mm ± 0,10
Length		5,5 mm ± 0,15
Height		2,0 mm ± 0,15
Basic material		Copper beryllium (CuBe)
Plating	Barrier layer NI Outer layer AU	1,25µm – 3,00µm 0,025µm



DIMENSIONS (mm)



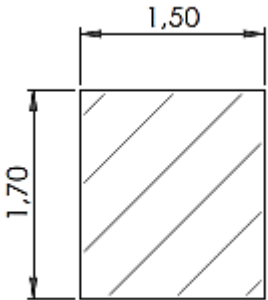
RECOMMENDED RESERVED AREA ON THE PCB (mm)



DISCLAIMER

This is only a recommendation based on information available to mtc at the time of printing. Actual land pattern can be significantly different due to various materials and processes used in PCB assembly. mtc makes no representation or warranty of performance based on the recommended land pattern.

RECOMMENDED PAD FOR THE PCB (mm)

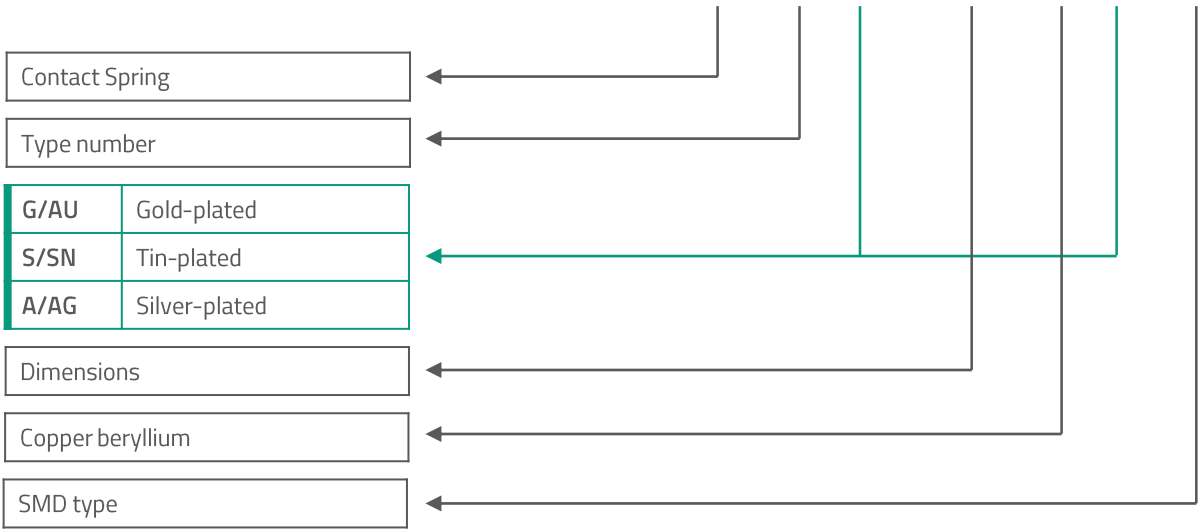


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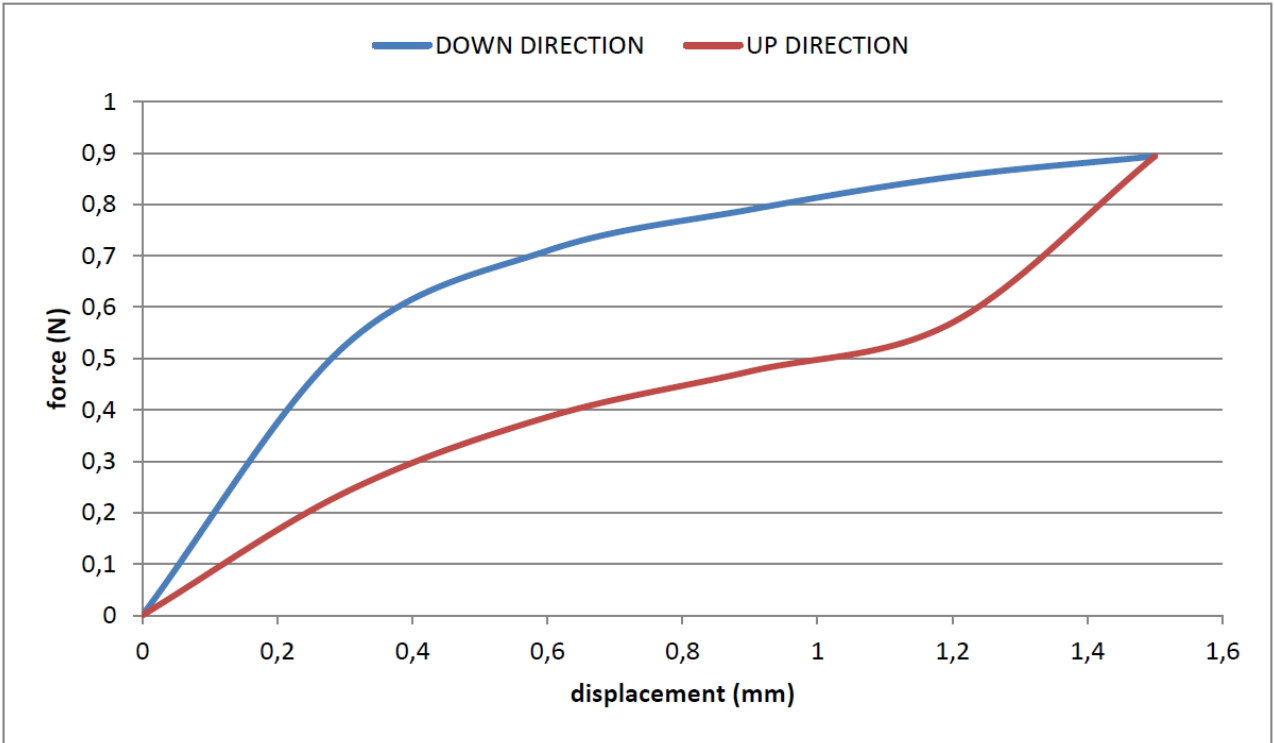
BUILDING AN ITEM NUMBER

FCB-25CX1555020B-YY-SMD



Standard options

FORCE DEFLECTION DIAGRAM*



NOTE | * Only valid for gold-plated version

Modifications and errors excepted. The information and statements herein are believed to be reliable but are not to be construed as a warranty or representation for which we assume legal responsibility. Users should undertake sufficient verifications and testings to determine the suitability for their own particular purpose of any information or products referred to herein.